

各種産業用パソコン(ボード) > シングルボードコンピュータ > 組込みCPUボード

WAFER-AL

3.5" SBC supports Intel® 14nm Generation Atom™ or Celeron® on-board SoC with DP++/VGA/LVDS/iDP support



Features

- » 3.5" SBC with Intel® Apollo Lake platform on-board SoC
- » One SO-DIMM DDR3L 1867/1600MHz support up to system maximum 8GB $\,$
- » Triple displays with 1 x DP++, 1 x VGA / 1 x iDP, 1 x LVDS selection
- » High speed I/O interface for USB 3.0, SATA 6Gb/s
- » PCIe Mini with mSATA support

Specifications

System		
CPU	Intel® Pentium® N4200 on-board SoC (up to 2.5GHz, quad-core, 2M Cache, TDP=6W)	
	Intel® Celeron® N3350 on-board SoC (up to 2.4GHz, dual-core, 2M Cache, TDP=6W)	
Memory	One 204-pin 1866/1600MHz Single-channel DDR3L DIMMs	
Memory Max.	8GB	
Physical Characteristics		
Dimensions (LxWxH) (mm)	146 X 102	
Net Weight	250	
Storage		
Storage	2 x SATA :6Gb/s with 5V SATA power connector (no RAID)	
I/O Interface		
Display Output	1 x VGA :up to 1920x1200@60Hz	
	1 x LVDS :18/24-bit dual-channel (up to 1920x1200@60Hz)	
	1 x iDP :colay with VGA, support by request	
Ethernet	2 x Description: PCIe GbE LAN Realtek RTL8111 Controller	
Audio	Description: Realtek ALC662 HD codec	
	1 x Front Audio :2x5 pin	
I/O Interface	2 x Internal RS-232 :1x9 pin, P=1.25	
	2 x Internal RS-232/422/485 :1x9 pin, P=1.25	
	4 x Internal USB 2.0 :2x4 pin, P=2.0	
Expansion	2 x PCIe mini Card Slot :1 x supports mSATA, colay with SATA port 2, 1 x supports SIM card holder	
Other Features		
TPM	2x10 pin	
Power		
Power Consumption	12V@2.57A (Intel® Pentium® N4200 up to 2.5GHz with 8GB DDR3L memory)	
Power Supply	12V DC input power	
	Support AT/ATX mode	
Environment		
Operating Temperature	-20°C ~ 70°C	
Storage Temperature	-20°C ~ 70°C	
Humidity	5% ~ 95%, non-condensing	
Certifications		
Safety & EMC	CE/FCC compliant	



Ordering Information

WAFER-AL-N2-R11	3.5" SBC supports Intel® 14nm quad-core Pentium® N4200 2.5GHz on-board SoC with tripple display, Dual PCIe GbE, USB 3.0, PCIe Mini with mSATA support, SATA 6Gb/s, COM, Audio and RoHS
WAFER-AL-N1-R11	3.5" SBC supports Intel® 14nm dual-core Celeron® N3350 2.4GHz on-board SoC with tripple display, Dual PCIe GbE, USB 3.0, PCIe Mini with mSATA support, SATA 6Gb/s, COM, Audio and RoHS

Packing List

1 x WAFER-AL single board computer	1 x Power cable
1 x RS-232/422/485 cable	1 x QIG
1 x SATA with power cable kit	

Intel® 14nm GEN Atom™ Apollo Lake



Improved 3D & Full-HD Media Performance

- » Fast HD video acceleration over previous generation
- » Up to 15 simultaneous 1080p30 decode streams
- » Fast graphics and media performance @ ISO power over previous generation



Reliable and Efficient Computing

- » » Highly reliability with ECC
- » Wide termperatue SKU with Tj: -40°C \sim 110°C and extreme 15-years lifetime for Industrial applications



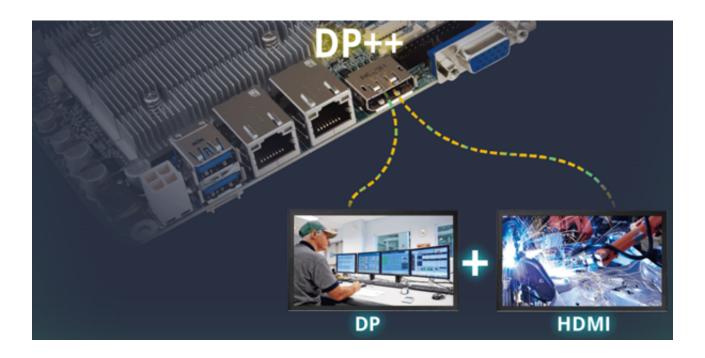
Enhanced Security Executions

- » Integral Intel® Security Engine
- » Fast cryptographic execution with Intel® AES New Instructions (Intel® AES-NI)
- » Secure/measured booting features

DP++ Dual-mode Output

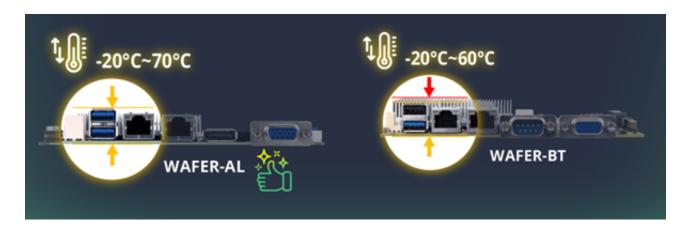
IEI provides products support Dual-mode DisplayPort output which can auto detect the plugged-in cable type and provide multiple option of display output in single port.



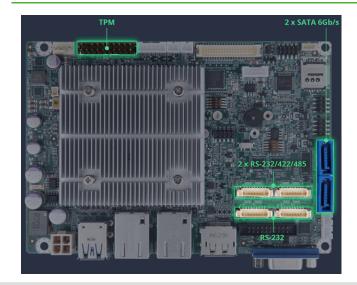


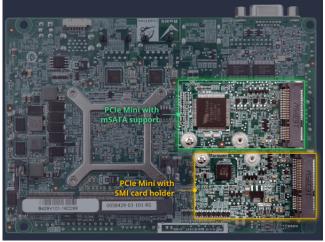
Low Profile, Flexible Deployment

Thin type products with single layer rear I/O and low profile thermal solution design are suitable for open frame panel PC solutions and also the best choice for thin compact size embedderd box solutions.



Product Overview









Application Field

The WAFER-AL, a 3.5" SBC, has a PCIe Mini slot and a SIM card holder to support Wi-Fi or LTE modules, allowing the system to transfer real-time data to the management center over OCPP protocol. Therefore, EV charging stations and central management systems from different vendors can communicate with each other securely. USB ports and RS-232 ports are also available for NFC payment system connection. The on-board Intel® Apollo Lake processor consumes only 6 W, which is ideal for IoT application while enabling fanless operation and eliminating CPU fans. Other application field including factory automation, smart home and medical equipment manufacturing.

